

1200V SiC Schottky Diode

V _{DC}	1200 V
Q _C	86 nC
I _F	15 A
T _{j,max}	175 °C

Amp+™ Features

- Unipolar rectifier with surge current
- Zero reverse recovery current
- Fast, temperature-independent switching
- Avalanche tested to 200mJ*
- All parts tested to greater than 1,400V

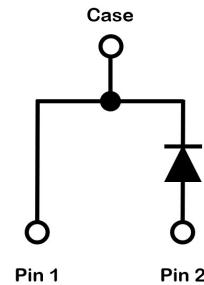
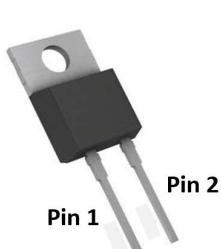
Amp+™ Benefits

- Near zero switching loss
- Higher efficiency
- Smaller heat sink
- Easy to parallel

Amp+™ Applications

- Solar Inverters
- Switch mode power supplies, UPS
- Power factor correction
- EV charging stations

Package



Part #	Package	Marking
GP3D015A120A	TO-220-2L	3D015A120



Maximum Ratings, at T_j=25 °C, unless otherwise specified

Characteristics	Symbol	Conditions	Values	Unit
Continuous forward current	I _F **	T _C =25 °C, T _j =175 °C	49	A
		T _C =125 °C, T _j =175 °C	27	
		T _C =150 °C, T _j =175 °C	18	
Surge non-repetitive forward current sine halfwave	I _{FSM}	T _C =25 °C, t _p =8.3 ms	150	A
		T _C =110 °C, t _p =8.3 ms	120	
Non-repetitive peak forward current	I _{F,max}	T _C =25 °C, t _p =10 µs	900	A
i ² t value	∫i ² dt	T _C =25 °C, t _p =8.3 ms	93	A ² s
		T _C =110 °C, t _p =8.3 ms	60	
Repetitive peak reverse voltage	V _{RRM}	T _j =25 °C	1200	V
Diode dv/dt ruggedness	dv/dt	Turn-on slew rate, repetitive	200	V/ns
Power dissipation	P _{tot} **	T _C =25 °C	252	W
Operating junction & storage temperature	T _j , T _{storage}	Continuous	-55...175	°C
Soldering temperature	T _{solder}	Wave soldering leads	260	°C
Mounting torque		M3 Screw	1	N-m

Notes:

* EAS of 200 mJ is based on starting T_j = 25°C, L = 1.0 mH, IAS = 20.00 A, V = 50 V.

** Typical R_{thJC} used

Electrical Characteristics, at $T_j=25\text{ }^\circ\text{C}$, unless otherwise specified

Characteristics	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
DC blocking voltage	V_{DC}	$T_j=25\text{ }^\circ\text{C}$	1200	-	-	V
Breakdown voltage	V_{BR}	$I_R=1.00\text{mA}, T_j=25\text{ }^\circ\text{C}$	1400	-	-	V
Diode forward voltage	V_F	$I_F=15\text{A}, T_j=25\text{ }^\circ\text{C}$	-	1.48	1.60	V
		$I_F=15\text{A}, T_j=125\text{ }^\circ\text{C}$	-	1.79	-	
		$I_F=15\text{A}, T_j=175\text{ }^\circ\text{C}$	-	2.10	2.70	
Reverse current	I_R	$V_R=1,200\text{V}, T_j=25\text{ }^\circ\text{C}$	-	1	30	μA
		$V_R=1,400\text{V}, T_j=25\text{ }^\circ\text{C}$	-	6	-	
		$V_R=1,200\text{V}, T_j=125\text{ }^\circ\text{C}$	-	10	-	
		$V_R=1,200\text{V}, T_j=175\text{ }^\circ\text{C}$	-	41	450	
Total capacitive charge	Q_C	$V_R=800\text{V}, T_j=25\text{ }^\circ\text{C}$	-	86	-	nC
Total capacitance	C	$V_R=1\text{V}, f=1\text{ MHz}$	-	962	-	pF
		$V_R=400\text{V}, f=1\text{ MHz}$	-	81	-	
		$V_R=800\text{V}, f=1\text{ MHz}$	-	59	-	

Thermal Characteristics

Characteristics	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal resistance, junction-case	R_{thJC}	-	-	0.60	0.74	$^\circ\text{C/W}$

Typical Performance

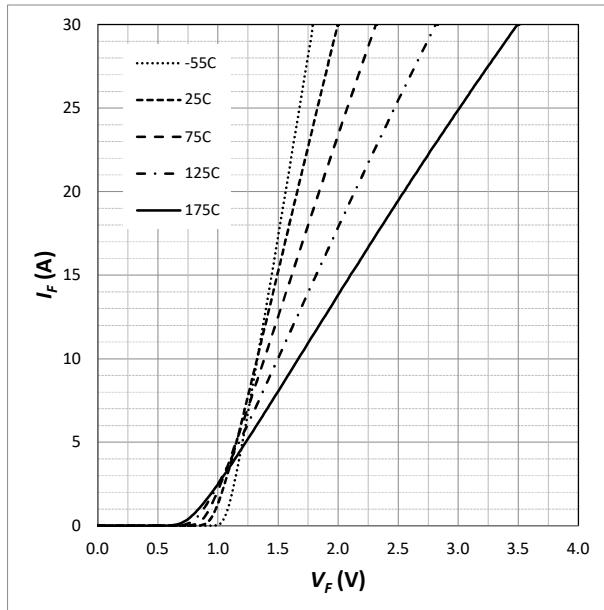


Fig. 1 Forward Characteristics (parameterized on T_j)

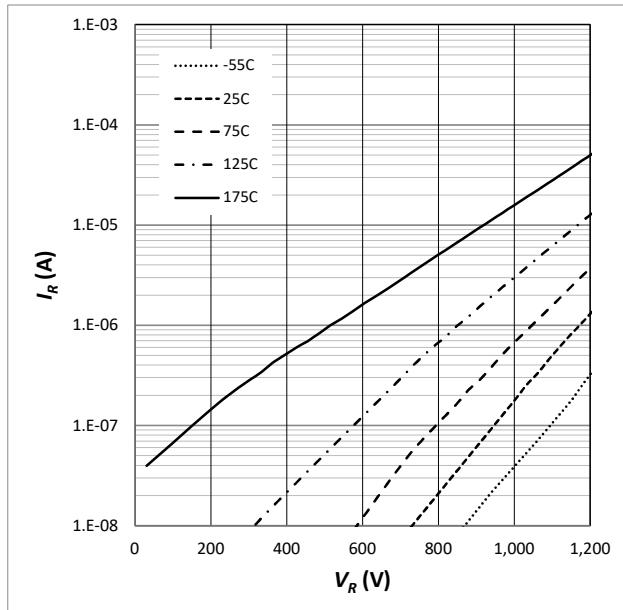


Fig. 2 Reverse Characteristics (parameterized on T_j)

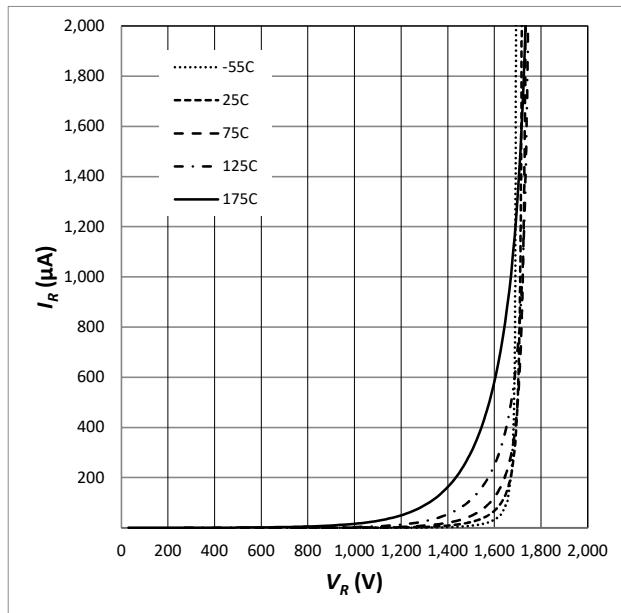
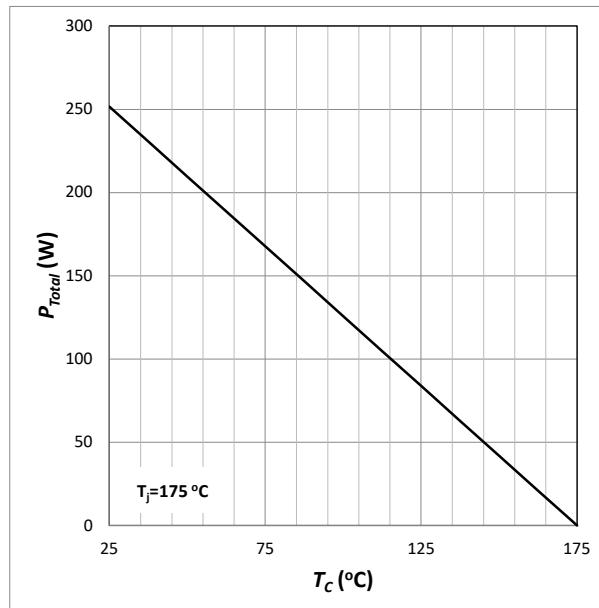
Fig. 3 Reverse Characteristics (parameterized on T_j)

Fig. 4 Power Derating

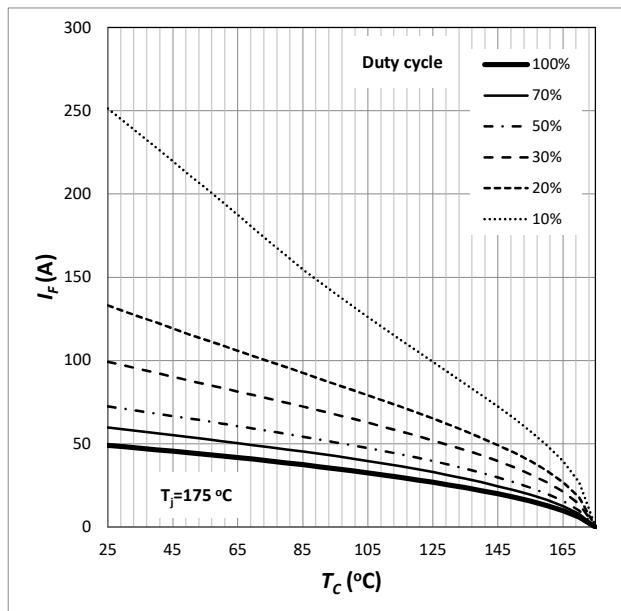


Fig. 5 Capacitance

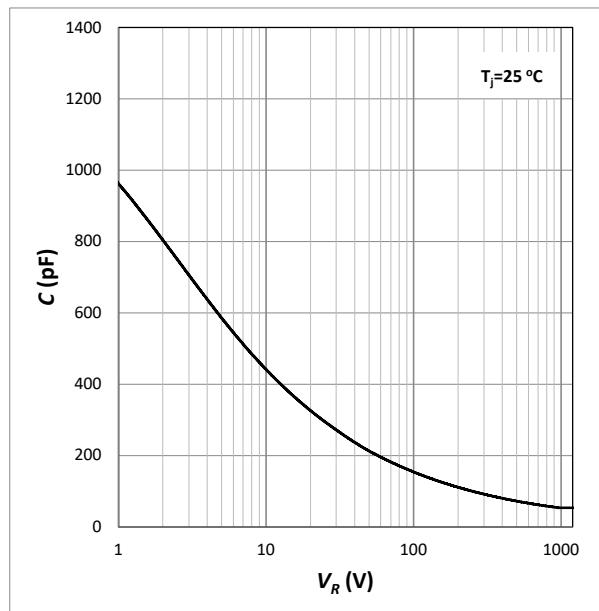


Fig. 6 Capacitance

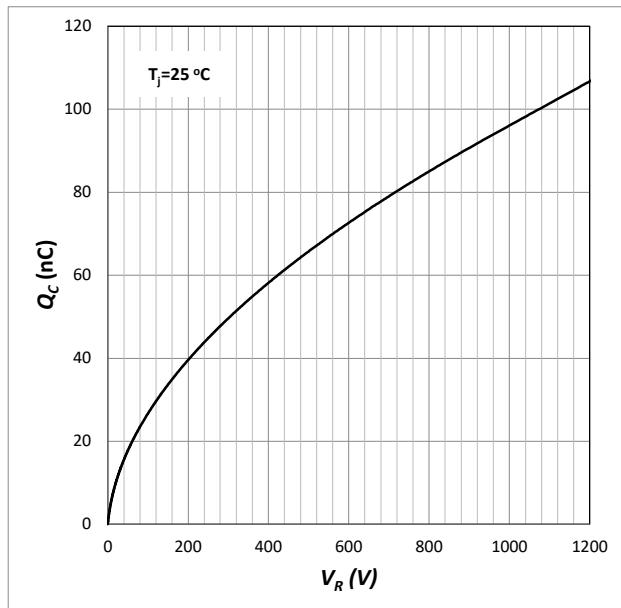


Fig. 7 Capacitive Charge

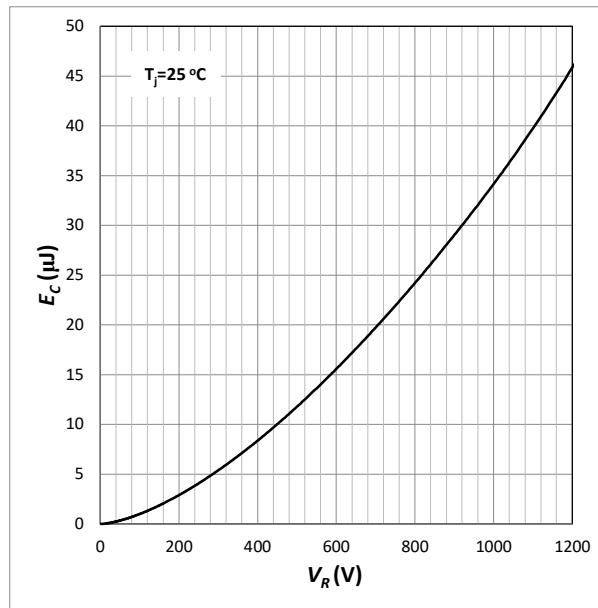


Fig. 8 Typical Capacitance Stored Energy

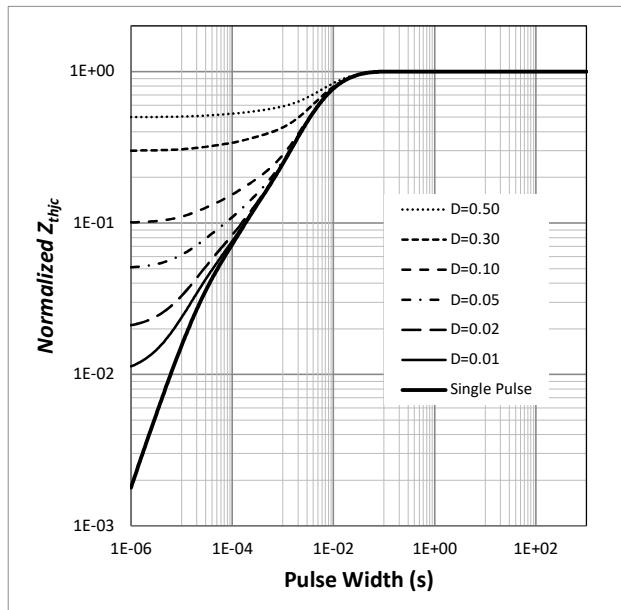


Fig. 9 Transient Thermal Impedance